# International **IGR** Rectifier

# SCHOTTKY RECTIFIER

# 10MQ040N

## 2.1 Amp

# $I_{F(AV)} = 2.1 Amp$ $V_R = 40V$

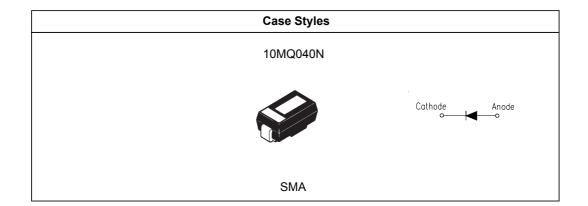
Major Ratings and Characteristics					
Cha	racteristics	Value	Units		
I <sub>F</sub>	DC	2.1	A		
V <sub>RRM</sub>		40	V		
I <sub>FSM</sub>	@ tp = 5 µs sine	120	А		
V <sub>F</sub>	@1.5Apk, T <sub>J</sub> =125°C	0.56	V		
Т	range	- 55 to 150	°C		

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#### **Description/ Features**

The 10MQ040N surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, free-wheeling diodes, battery charging, and reverse battery protection.

- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability



#### 10MQ040N

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#### Voltage Ratings

Part number	10MQ040N	
V <sub>R</sub> Max. DC Reverse Voltage (V)	- 40	
V <sub>RWM</sub> Max. Working Peak Reverse Voltage (V)		

### Absolute Maximum Ratings

Parameters		10MQ	Units	Conditions	
I <sub>F(AV)</sub> Max. Average Forward Current * See Fig. 4		1.5	A	50% duty cycle @ $T_L$ = 123 °C, rectangular wave form On PC board 9mm <sup>2</sup> island(.013mm thick copper pad area	
I <sub>FSM</sub>	Max. Peak One Cycle Non-Repetitive	120	Α	5µs Sine or 3µs Rect. pulse	Following any rated load condition and with rated V <sub>RRM</sub> applied
	Surge Current * See Fig. 6	30		10ms Sine or 6ms Rect. pulse	
E <sub>AS</sub>	Non-Repetitive Avalanche Energy	3.0	mJ	$T_J = 25 ^{\circ}C, I_{AS} = 1A, L = 6mH$	
I <sub>AR</sub>	Repetitive Avalanche Current	1.0	Α		

### **Electrical Specifications**

	Parameters	10MQ	Units		Conditions
V <sub>EM</sub>	Max. Forward Voltage Drop (1)	0.54	V	@ 1A	T,= 25 °C
	* See Fig. 1	0.62	V	@ 1.5A	1 <sub>1</sub> = 25 C
		0.49	V	@ 1A	T = 125 °C
		0.56	V	@ 1.5A	1, 125 0
I <sub>RM</sub>	Max. Reverse Leakage Current (1)	0.5	mA	T <sub>J</sub> = 25 °C	$V_{p}$ = rated $V_{p}$
	* See Fig. 2	26	mA	T <sub>J</sub> = 125 °C	$v_{\rm R}$ – faced $v_{\rm R}$
V <sub>F(TO</sub>	V <sub>F(TO)</sub> Threshold Voltage		V	$T_J = T_J max.$	
r, Forward Slope Resistance		104	mΩ		
CT	C <sub>T</sub> Typical Junction Capacitance		pF	$V_R = 10V_{DC}, T_J = 25^{\circ}C$ , test signal = 1Mhz	
L <sub>S</sub>	L <sub>S</sub> Typical Series Inductance		nH	Measured lead to lead 5mm from package body	
dv/dt	Max. Voltage Rate of Change	10000	V/µs		
	(Rated V <sub>R</sub> )				

(1) Pulse Width < 300µs, Duty Cycle < 2%

#### **Thermal-Mechanical Specifications**

	Parameters		Units	Conditions
TJ	Max. Junction Temperature Range (*)	- 55 to 150	°C	
T <sub>stg</sub>	Max. Storage Temperature Range	- 55 to 150	°C	
R <sub>thJA</sub>	Max. Thermal Resistance Junction to Ambient	80	°C/W	DC operation
wt	Approximate Weight	0.07(0.002)	g (oz.)	
	Case Style			Similar D-64
	Device Marking IR1F			

(\*) dPtot

1 < <del>|</del> Rth(j-a) thermal runaway condition for a diode on its own heatsink dTj